

## PALM INTRANET

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## Inventor Name Search Result Office of Public Affairs

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Last Name = CALETKA

First Name = DAVID

Application#	Patent#	PG Pub#	Status	Date Filed	Title	Examiner Name	Inventor Name
<a href="#">12010335</a>	Not Issued	20080142258	025	01/24/2008	HIGH SPEED INTERPOSER		CALETKA, DAVID V.
<a href="#">11152048</a>	<a href="#">7253518</a>	20060284304	150	06/15/2005	WIREBOND ELECTRONIC PACKAGE WITH ENHANCED CHIP PAD DESIGN, METHOD OF MAKING SAME, AND INFORMATION HANDLING SYSTEM UTILIZING SAME	HA,NATHAN	CALETKA, DAVID V.
<a href="#">12010469</a>	Not Issued	20080120835	025	01/25/2008	METHOD OF MAKING HIGH SPEED INTERPOSER		CALETKA, DAVID V.
<a href="#">11822573</a>	Not Issued	20070254408	030	07/09/2007	METHOD OF MAKING WIREBOND ELECTRONIC PACKAGE WITH ENHANCED CHIP PAD DESIGN	FAHMY,WAEL	CALETKA, DAVID V.
<a href="#">09570895</a>	<a href="#">6410988</a>		150	05/15/2000	THERMALLY ENHANCED AND MECHANICALLY BALANCED FLIP CHIP PACKAGE AND METHOD OF FORMING	LE,BAU	CALETKA, DAVID V.
<a href="#">09605173</a>	<a href="#">6603195</a>		150	06/28/2000	PLANARIZED PLASTIC PACKAGE MODULES FOR INTEGRATED CIRCUITS	WILLIAMS,ALEXANDER	CALETKA, DAVID V.
<a href="#">09649318</a>	<a href="#">6293455</a>		150	08/28/2000	METHOD FOR PRODUCING A RELIABLE BGA SOLDER JOINT INTERCONNECTION	DUNN,COLLEEN	CALETKA, DAVID V.
<a href="#">10692921</a>	Not Issued	20050089264	077	10/24/2003	PASSIVE ALIGNMENT OF VCSELS TO WAVEGUIDES IN OPTO-ELECTRONIC CARDS AND PRINTED CIRCUIT BOARDS	HEALY,BRIAN	CALETKA, DAVID V.
<a href="#">10717946</a>	<a href="#">6913948</a>	20040099936	150	11/20/2003	PARTIALLY CAPTURED ORIENTED INTERCONNECTIONS FOR BGA PACKAGES AND A METHOD OF FORMING THE INTERCONNECTIONS	MITCHELL,JAMES	CALETKA, DAVID V.
<a href="#">10273786</a>	<a href="#">6933619</a>	20030034569	150	10/18/2002	ELECTRONIC PACKAGE AND METHOD OF FORMING	ANDUJAR,LEONARDO	CALETKA, DAVID V.
<a href="#">10215451</a>	<a href="#">6649833</a>	0	150	08/09/2002	NEGATIVE VOLUME EXPANSION LEAD-FREE ELECTRICAL CONNECTION	NGO,HUNG	CALETKA, DAVID V.
<a href="#">09871554</a>	<a href="#">6695623</a>	20020182900	150	05/31/2001	ENHANCED ELECTRICAL/MECHANICAL CONNECTION FOR ELECTRONIC DEVICES	GILMAN,ALEXANDER	CALETKA, DAVID V.
<a href="#">09801948</a>	<a href="#">6672500</a>	20010045445	250	03/07/2001	METHOD FOR PRODUCING A RELIABLE SOLDER JOINT INTERCONNECTION	EDMONDSON,LYNNE	CALETKA, DAVID V.
<a href="#">09860549</a>	<a href="#">6433283</a>	20010020541	150	05/21/2001	DUAL PURPOSE RIBBON CABLE	NGUYEN,CHAU	CALETKA, DAVID V.

<u>11454896</u>	Not Issued	20070289773	041	06/19/2006	HIGH SPEED INTERPOSER	PATEL,ISHWARBHAI	CALETKA, DAVID V.
<u>09656941</u>	<u>6333551</u>		150	09/07/2000	SURFACE PROFILING IN ELECTRONIC PACKAGES FOR REDUCING THERMALLY INDUCED INTERFACIAL STRESSES	CLARK,SHEILA	CALETKA, DAVID V.
<u>09754782</u>	<u>6541857</u>	20010000925	150	01/04/2001	METHOD OF FORMING BGA INTERCONNECTIONS HAVING MIXED SOLDER PROFILES	LEE,EUGENE	CALETKA, DAVID V.
<u>09491066</u>	<u>6268567</u>		250	01/25/2000	DUAL PURPOSE RIBBON CABLE	NGUYEN,CHAU	CALETKA, DAVID V.
<u>12015604</u>	Not Issued	20080119029	030	01/17/2008	WAFER SCALE THIN FILM PACKAGE	GRAYBILL,DAVID	CALETKA, DAVID VINCENT
<u>10336579</u>	<u>6905961</u>	20030090000	150	01/03/2003	LAND GRID ARRAY STIFFENER FOR USE WITH FLEXIBLE CHIP CARRIERS	THALLUAN	CALETKA, DAVID VINCENT
<u>11440316</u>	Not Issued	20060208030	061	05/24/2006	METHOD TO ACCOMMODATE INCREASE IN VOLUME EXPANSION DURING SOLDER REFLOW	NGUYEN,DONGHAI	CALETKA, DAVID VINCENT
<u>09626904</u>	<u>6627998</u>		150	07/27/2000	WAFER SCALE THIN FILM PACKAGE	WILLIAMS,ALEXANDER	CALETKA, DAVID VINCENT
<u>09845448</u>	<u>6686664</u>	20020158110	150	04/30/2001	STRUCTURE TO ACCOMMODATE INCREASE IN VOLUME EXPANSION DURING SOLDER REFLOW	TRINH,HOA	CALETKA, DAVID VINCENT
<u>09874196</u>	<u>6528892</u>	20020180061	150	06/05/2001	LAND GRID ARRAY STIFFENER USE WITH FLEXIBLE CHIP CARRIERS	THALLUAN	CALETKA, DAVID VINCENT
<u>09855308</u>	<u>6595784</u>	20020173175	150	05/15/2001	INTERPOSER MEMBER HAVING APERTURES FOR RELIEVING STRESS AND INCREASING CONTACT COMPLIANCY	HAMMOND,BRIGGITTE	CALETKA, DAVID VINCENT
<u>10768836</u>	<u>7086147</u>	20040183094	150	01/29/2004	STRUCTURE TO ACCOMMODATE INCREASE IN VOLUME EXPANSION DURING SOLDER REFLOW	NGUYEN,DONGHAI	CALETKA, DAVID VINCENT
<u>10438947</u>	<u>7348261</u>	20030199121	150	05/15/2003	WAFER SCALE THIN FILM PACKAGE	GRAYBILL,DAVID	CALETKA, DAVID VINCENT

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